



## Kun Xu

Postdoctoral Scholar, Mechanical Engineering

### Bio

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#### BIO

2022, PhD in Materials Science and Engineering, Tsinghua University

#### STANFORD ADVISORS

- Arunava Majumdar, Postdoctoral Faculty Sponsor

### Research & Scholarship

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#### CURRENT RESEARCH AND SCHOLARLY INTERESTS

Materials characterization by using advanced electron microscopy

### Publications

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#### PUBLICATIONS

- **Topotactically transformable antiphase boundaries with enhanced ionic conductivity.** *Nature communications*  
Xu, K., Hung, S. W., Si, W., Wu, Y., Huo, C., Yu, P., Zhong, X., Zhu, J.  
2023; 14 (1): 7382
- **Revealing the atomic mechanism of diamond-iron interfacial reaction** *CARBON ENERGY*  
Ku, Y., Xu, K., Yan, L., Zhang, K., Song, D., Li, X., Li, S., Cheng, S., Shan, C.  
2023
- **Colossal Ionic Conductivity in Interphase Strain-Engineered Nanocomposite Films.** *Journal of the American Chemical Society*  
Huo, C., Xu, K., Ma, L., Li, T., Li, H., Yang, X., Kuang, X., Liu, S., Deng, S., Chen, J.  
2023
- **Ultrathin Non-Ising Charged Domain Walls Confined in BiFeO<sub>3</sub> Nanocrystals** *ADVANCED FUNCTIONAL MATERIALS*  
Liu, L., Xu, K., Li, Q., Huang, Y., Shu, L., Cheng, Y., Zhang, S., Luo, J., Zhu, J., Li, J.  
2022; 32 (46)
- **Direct investigation of the atomic structure and decreased magnetism of antiphase boundaries in garnet.** *Nature communications*  
Xu, K., Lin, T., Rao, Y., Wang, Z., Yang, Q., Zhang, H., Zhu, J.  
2022; 13 (1): 3206
- **Atomic-scale insights into quantum-order parameters in bismuth-doped iron garnet.** *Proceedings of the National Academy of Sciences of the United States of America*  
Xu, K., Zhang, L., Godfrey, A., Song, D., Si, W., Zhao, Y., Liu, Y., Rao, Y., Zhang, H., Zhou, H. A., Jiang, W., Wang, W., Cheng, et al  
2021; 118 (20)

- **Interfacial oxygen-octahedral-tilting-driven electrically tunable topological Hall effect in ultrathin SrRuO<sub>3</sub> films** *JOURNAL OF PHYSICS D-APPLIED PHYSICS*

Gu, Y., Wei, Y., Xu, K., Zhang, H., Wan, F., Li, F., Saleem, M., Chang, C., Sun, J., Song, C., Feng, J., Zhong, X., Liu, et al  
2019; 52 (40)